

MICROFABRICATED TRAVELLING WAVE TUBE AMPLIFIERS

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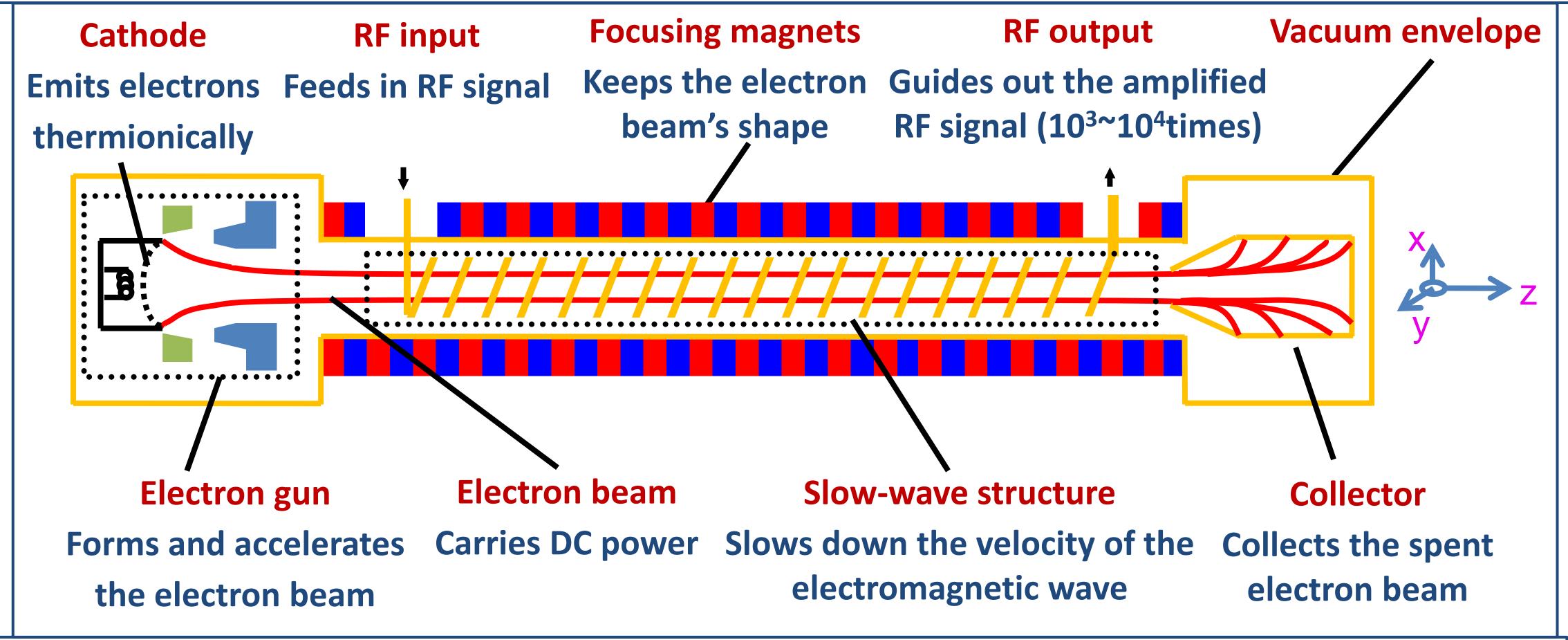
Hello, everyone!

This is traveling wave tube amplifier, and you can call me TWTA.

I am a vacuum electron device (VED) and I convert DC power into RF power.

Take a look at my cross-sectional diagram.

Actually, I am cylindrical and rotationally symmetric about z-axis.



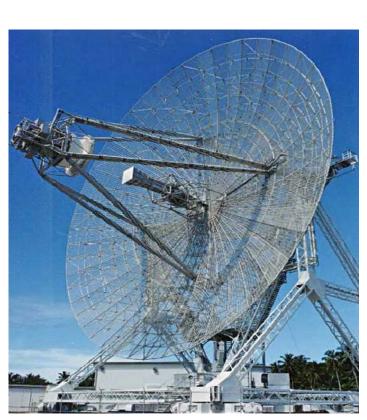
Many people like me, because I can work with a large bandwidth, good linearity, high efficiency, high frequency, medium power, high temperature ...

So, I have become the most widely used VED (65%), and you can find me in:









Satellites

UAVs

Airborne radars

Jammers in ECM

Military radars ...

And they call me the heart of the communication system.

I have got a large family with different types of slow wave structures:
Helix TWTA, Coupled Cavity TWTA, Folded Waveguide TWTA,
Ring-Bar TWTA, Ladder TWTA, Rectangular Grating TWTA...

Sigh, just as most of you, I do have some troubles.

Circular helix is not amenable to mass-production;
thermionic e-gun operates at high temperature;
difficult to scale up the frequency since dimensions become too small.

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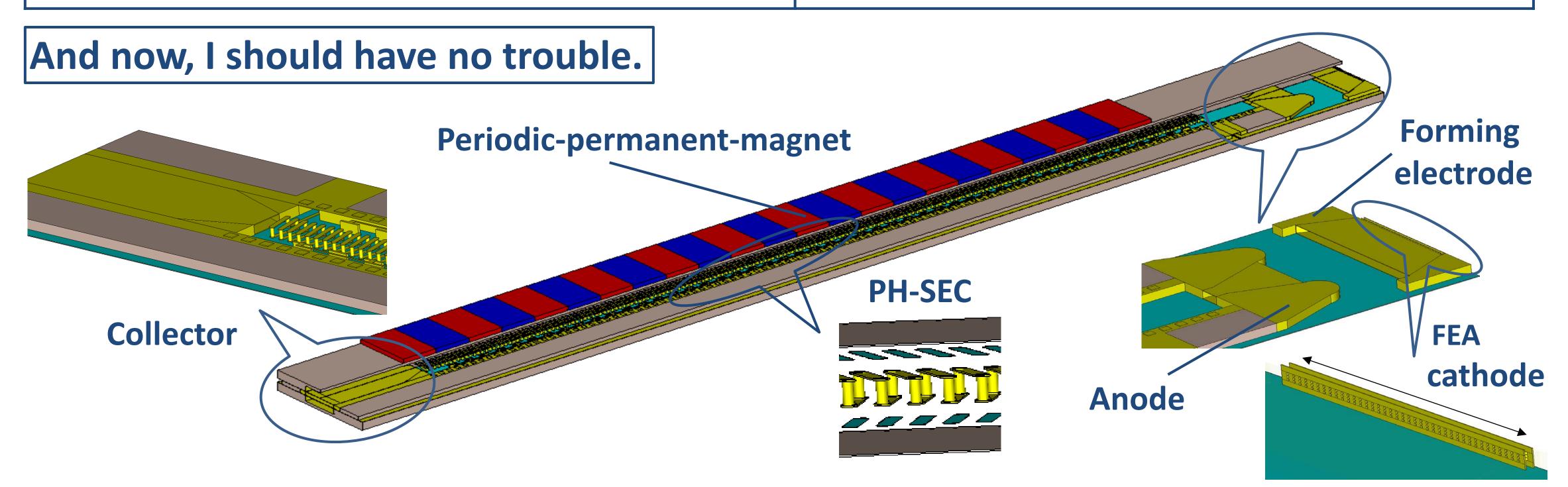
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Fortunately, problems can always be solved, can't they?

Here is the prescription from the research group in SaRC.

Problem	Solution
Circular helix is not amenable to mass-production	Planar helix is amenable to printed-circuit or micro-fabrication techniques
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Conventional helix	Planar helix slow-wave structure with straight-
	edge connections (PH-SEC)
Thermionic e-gun operates at high temperature	Field emitter arrays operate at room temperature
Strengthener Bushing Laser Weld Emission Pellet Heater Heat Shield Insulator Support Disk Primary Support Sleeve	
Thermionic cathode	Field emitter arrays (FEA) cathode
Difficult to scale up the frequency since	To scale up the frequency:
(a) Dimensions become very small	(a) Use micro-fabrication techniques
(b) Alignment issues become critical	(b) Fabricate various parts on a single platform
(c) Current density becomes high in a circular beam	(c) Use sheet-beam configuration
	a
Circular beam of diameter 'a'	Sheet beam with width 'w' and thickness 'a'
Difficult to scale up power due to limited heat	Planar helix has intimate contact with the
transfer	Substrate PH-SEC Metal enclosure Electron beam Si SiO ₂
	Surface contact



Estimated size L*W*H≈79mm*7.5mm*3.5mm